March 5, 2025

To the Embassy of Singapore in City, Country

On behalf of the Conference Organizing Committee, I am writing this letter to invite Your Full Name to attend the Applied Materials & Interfaces Conference (AMIC 2025), which will be held at Nanyang Technological University on July 3-5th, 2025 in Singapore. AMIC 2025 organized by Nanyang Technological University, is a premier forum for leading scientists and scholar worldwide to foster a collaborative platform to develop future applied materials and interfaces.

His personal information is as follows:

Passport number:

Surname:

Given name:

Nationality:

Sex:

Date of birth:

Date of issue:

Date of expiry:

This letter may be used as part of the supporting documents for applying a VISA to Singapore.

Details of the Applied Materials & Interfaces Conference (AMIC 2025) are provided on the conference website at <https://www.ami-conference.com/>.

For further information, please do not hesitate to contact me or the conference secretary via [info@ami-conference.com](mailto:info@ami-conference.com) .

Best regards,

Xingyi Ling

Professor

School of Chemistry, Chemical Engineering and Biotechnology

Nanyang Technological University, Singapore

<https://www.lingxingyi.com/>

Editor-in-Chief

ACS Applied Materials & Interfaces

ACS Applied Materials Portfolio Journals

The American Chemical Society